Electronic Patent Application Fee Transmittal								
Application Number:	10586335							
Filing Date:	09-Jan-2007							
Title of Invention:	Multilayer printed wiring board and test body for printed wiring board							
First Named Inventor/Applicant Name:	Takahiro Yamashita							
Filer:	Marvin Jay Spivak/Nina Leta							
Attorney Docket Number:	293627US40PCT							
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Claims in excess of 20		1615	4	52	208			
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			208